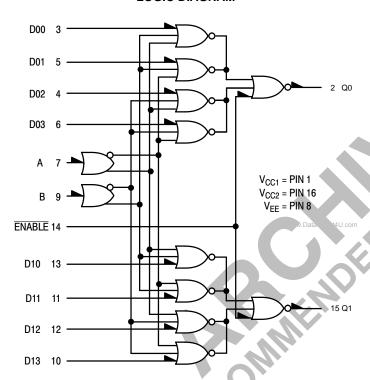
Dual 4 to 1 Multiplexer

The MC10174 is a high speed dual channel multiplexer with output enable capability. The select inputs determine one of four active data inputs for each multiplexer. An output enable forces both outputs low when in the high state.

- $P_D = 305 \text{ mW typ/pkg (No Load)}$
- $t_{pd} = 3.5$ ns typ (Dta to output)
- t_r , $t_f = 2.0$ ns typ (20%–80%)

LOGIC DIAGRAM



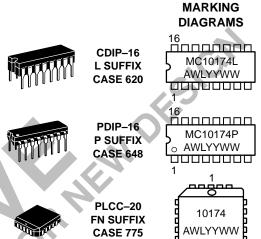
TRUTH TABLE

ENABLE	ADDRESS	SINPUTS	OUTPUTS						
Ē	В	ВА		Q1					
Н	X	Х	L	L					
L	L	L	D00	D10					
L	7	Н	D01	D11					
L	Н	L	D02	D12					
L	Н	Н	D03	D13					



ON Semiconductor

http://onsemi.com

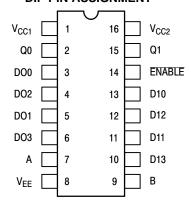


A = Assembly Location

WL = Wafer Lot YY = Year

WW = Work Week

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

ORDERING INFORMATION

Device	Package	Shipping		
MC10174L	CDIP-16	25 Units / Rail		
MC10174P	PDIP-16	25 Units / Rail		
MC10174FN	PLCC-20	46 Units / Rail		

ELECTRICAL CHARACTERISTICS

						٦	Test Limits	3			
Characteristic Syı		Pin	Pin Under	_30°C		+25°C		+85°C		1	
		Symbol	Test	Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply	Drain Current	Ι _Ε	8		80		58	73	80		mAdc
Input Current		l _{inH}	4 14		350 525			220 330		220 330	μAdc
		I _{inL}	4	0.5		0.5			0.3		μAdc
Output Voltage	e Logic 1	V _{OH}	15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	e Logic 0	V _{OL}	15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Volta	age Logic 1	V _{OHA}	15	-1.080		-0.980			-0.910		Vdc
Threshold Volta	age Logic 0	V _{OLA}	15		-1.655			-1.630		-1.595	Vdc
Switching Time	es (50Ω Load)									C	ns
Propagation De	elay	t ₁₃₊₁₅₊ t ₁₃₋₁₅₋ t ₇₊₁₅₋ t ₇₋₁₅₊ t ₁₄₊₁₅₋ t ₁₄₋₁₅₊	15 15 15 15 15 15	1.4 1.4 1.9 1.9 1.0	5.0 5.0 6.6 6.6 3.3 3.3	1.5 1.5 2.0 2.0 1.0	3.5 3.5 5.0 5.0 2.0 2.0	4.7 4.7 6.2 6.2 3.1 3.1	1.4 1.4 2.1 2.1 0.9 0.9	5.0 5.0 6.6 6.6 3.4 3.4	
Rise Time	(20 to 80%)	t+	15	1.0	3.4	1.1	2.0	3.3	1.1	3.6	
Fall Time	(20 to 80%)	t–	15	1.0	3.4	1.1	2.0	3.3	1.1	3.6	

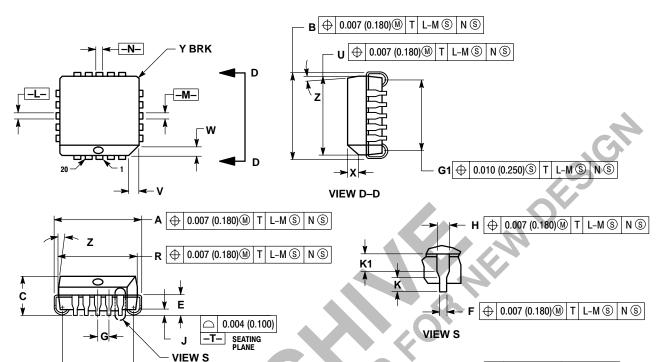
ELECTRICAL CHARACTERISTICS (continued)

ELECTRICAL CHARACTERIST	ioo (oontina	Ju)						
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the		TEST VOLTAGE VALUES (Volts)						
test table, after thermal equilibrium has been established. The circuit is in a test socket or mounte	@ Test Te	@ Test Temperature -30°C +25°C		V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
on a printed circuit board and transverse air flor greater than 500 linear fpm is maintained. Output	/			-1.890	-1.205	-1.500	-5.2	
are terminated through a 50-ohm resistor to -2. volts. Test procedures are shown for only on)			-1.850	-1.105	-1.475	-5.2	1
gate. The other gates are tested in the same mar ner.		+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
		Pin	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
Characteristic	Symbol	Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	(V _{CC}) Gnd
Power Supply Drain Current	ΙĘ	8					8	1, 16
Input Current	I _{inH}	4 14	4 14				8 8	1, 16 1, 16
	l _{inL}	4		4			8	1, 16
Output Voltage Logic	V _{OH}	15	13				8	1, 16
Output Voltage Logic	V _{OL}	15	14				8	1, 16
Threshold Voltage Logic	V _{OHA}	15			13		8	1, 16
Threshold Voltage Logic) V _{OLA}	15			14		8	1, 16
Switching Times (50Ω Load)		+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₁₃₊₁₅₊	15			13	15	8	1, 16
- repagation Delay	t ₁₃₋₁₅₋	15			13	15	8	1, 16
	t ₇₊₁₅₋	15	11		7	15	8	1, 16
	t _{7–15+}	15	11		7	15	8	1, 16
	t ₁₄₊₁₅	15	13		14	15	8	1, 16
	t ₁₄₋₁₅₊	15	13		14	15	8	1, 16
Rise Time (20 to 80%) t+	15	13		14	15	8	1, 16
Fall Time (20 to 80%) t–	15	13		14	15	8	1, 16

PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



NOTES:

G1 ⊕ 0.010 (0.250)③ T L-M ⑤ N ⑤

OF MICE. NOT PERSON

- IOTES:

 1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

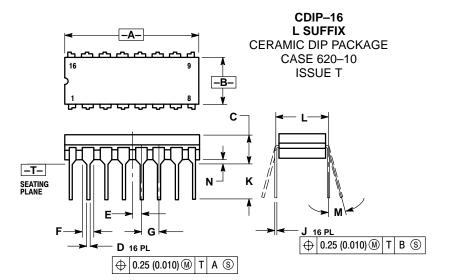
 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY

EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Ε	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y		0.020		0.50
Z	2°	10°	2°	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	



NOTES:

- ANIES.

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

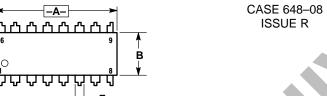
 CONTROLLING DIMENSION: INCH.

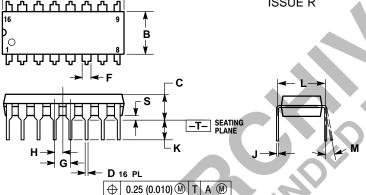
 DIMENSION L TO CENTER OF LEAD WHEN

- FORMED PARALLEL.
 DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62	BSC 4	
M	0 °	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE





- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIN	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0 °	10 °	
S	0.020	0.040	0.51	1.01	

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